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**PRELIMINARY**

**CY2XP21**

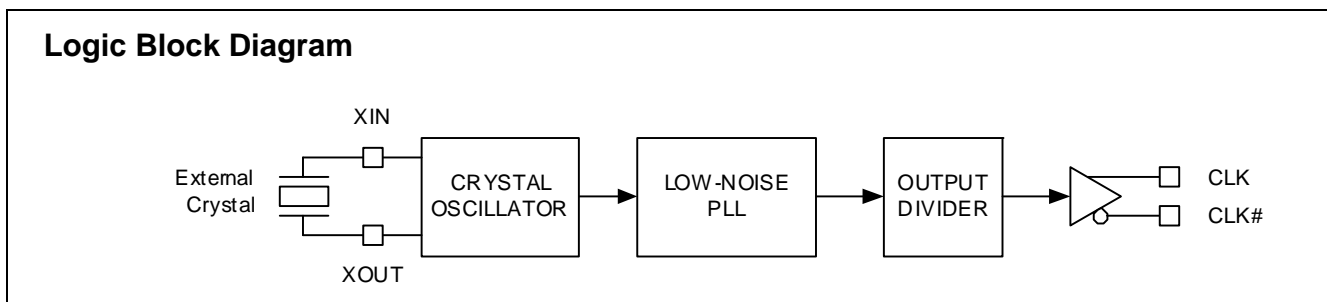
# 125 MHz LVPECL Clock Generator

## Features

- One LVPECL Output Pair
- Output Frequency: 112 MHz to 140 MHz
- External Crystal Frequency: 22.4 MHz to 28 MHz
- Low RMS Phase Jitter at 125 MHz, using 25 MHz Crystal (1.875 MHz to 20 MHz): 0.4 ps (Typical)
- Pb-free 8-Pin TSSOP Package
- Supply Voltage: 3.3V or 2.5V
- Commercial and Industrial Temperature Ranges

## Functional Description

The CY2XP21 is a PLL (Phase Locked Loop) based high performance clock generator. It is optimized to generate a 125 MHz clock, which is ideal for 10 Gb Ethernet applications. It also produces an output frequency that is five times the crystal frequency. It uses Cypress's low noise VCO technology to achieve less than 1 ps typical RMS phase jitter. The CY2XP21 has a crystal oscillator interface input and one LVPECL output pair.



## Pinouts

Figure 1. Pin Diagram - 8-Pin TSSOP

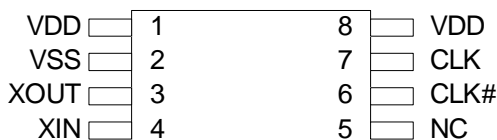


Table 1. Pin Definition - 8-Pin TSSOP

Pin Number	Pin Name	I/O Type	Description
1, 8	VDD	Power	3.3V or 2.5V power supply
2	VSS	Power	Ground
3, 4	XOUT, XIN	XTAL output and input	Parallel resonant crystal interface
5	NC		No Connect
6,7	CLK#, CLK	LVPECL output	Differential clock output

## Frequency Table

Inputs		Output Frequency (MHz)
Crystal Frequency (MHz)	PLL Multiplier Value	
25	5	125
26.6	5	133

## Absolute Maximum Conditions

Parameter	Description	Conditions	Min	Max	Unit
V <sub>DD</sub>	Supply Voltage		-0.5	4.4	V
V <sub>IN</sub> <sup>[1]</sup>	Input Voltage, DC	Relative to V <sub>SS</sub>	-0.5	V <sub>DD</sub> + 0.5	V
T <sub>S</sub>	Temperature, Storage	Non operating	-65	150	°C
T <sub>J</sub>	Temperature, Junction		-	135	°C
ESD <sub>HBM</sub>	ESD Protection, Human Body Model	JEDEC STD 22-A114-B	2000	-	V
UL-94	Flammability Rating	At 1/8 in.	V-0		
θ <sub>JA</sub> <sup>[2]</sup>	Thermal Resistance, Junction to Ambient	0 m/s airflow	100		°C/W
		1 m/s airflow	91		
		2.5 m/s airflow	87		

## Operating Conditions

Parameter	Description	Min	Max	Unit
V <sub>DD</sub>	3.3V Supply Voltage	3.135	3.465	V
	2.5V Supply Voltage	2.375	2.625	V
T <sub>A</sub>	Ambient Temperature, Commercial	0	70	°C
	Ambient Temperature, Industrial	-40	85	°C
T <sub>PU</sub>	Power up time for all V <sub>DD</sub> to reach minimum specified voltage (ensure power ramps is monotonic)	0.05	500	ms

## DC Electrical Characteristics

Parameter	Description	Test Conditions	Min	Typ	Max	Unit
I <sub>DD</sub>	Operating Supply Current with output unterminated	V <sub>DD</sub> = 3.465V, Output unterminated	-	-	125	mA
		V <sub>DD</sub> = 2.625V, Output unterminated	-	-	120	mA
I <sub>DDT</sub>	Operating Supply Current with output terminated	V <sub>DD</sub> = 3.465V, Output terminated	-	-	150	mA
		V <sub>DD</sub> = 2.625V, Output terminated	-	-	145	mA
V <sub>OH</sub>	LVPECL Output High Voltage	V <sub>DD</sub> = 3.3V or 2.5V, R <sub>TERM</sub> = 50Ω to V <sub>DD</sub> - 2.0V	V <sub>DD</sub> - 1.15	-	V <sub>DD</sub> - 0.75	V
V <sub>OL</sub>	LVPECL Output Low Voltage	V <sub>DD</sub> = 3.3V or 2.5V, R <sub>TERM</sub> = 50Ω to V <sub>DD</sub> - 2.0V	V <sub>DD</sub> - 2.0	-	V <sub>DD</sub> - 1.625	V
V <sub>OD1</sub>	LVPECL Peak-to-Peak Output Voltage Swing	V <sub>DD</sub> = 3.3V or 2.5V, R <sub>TERM</sub> = 50Ω to V <sub>DD</sub> - 2.0V	600	-	1000	mV
V <sub>OD2</sub>	LVPECL Output Voltage Swing (V <sub>OH</sub> - V <sub>OL</sub> )	V <sub>DD</sub> = 2.5V, R <sub>TERM</sub> = 50Ω to V <sub>DD</sub> - 1.5V	500	-	1000	mV

### Notes

- The voltage on any input or IO pin cannot exceed the power pin during power up.
- Simulated using Apache Sentinel TI software. The board is derived from the JEDEC multilayer standard. It measures 76 x 114 x 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metalization. No vias are included in the model.

**DC Electrical Characteristics**

Parameter	Description	Test Conditions	Min	Typ	Max	Unit
V <sub>OCM</sub>	LVPECL Output Common Mode Voltage (V <sub>OH</sub> + V <sub>OL</sub> )/2	V <sub>DD</sub> = 2.5V, R <sub>TERM</sub> = 50Ω to V <sub>DD</sub> - 1.5V	1.2	–	–	V
C <sub>INX</sub> <sup>[3]</sup>	Pin Capacitance, XIN & XOUT		–	4.5	–	pF

**AC Electrical Characteristics<sup>[3]</sup>**

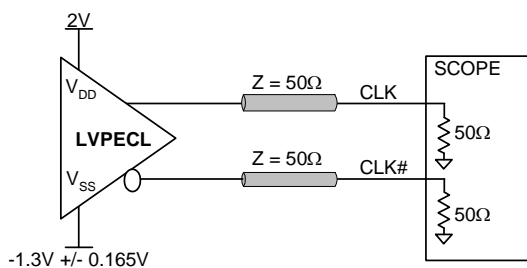
Parameter	Description	Conditions	Min	Typ	Max	Unit
F <sub>OUT</sub>	Output Frequency		112	–	140	MHz
T <sub>R</sub> , T <sub>F</sub>	Output Rise or Fall Time	20% to 80% of full output swing	–	0.5	1.0	ns
T <sub>Jitter(φ)</sub>	RMS Phase Jitter (Random)	125 MHz, (1.875–20 MHz)	–	0.4	–	ps
T <sub>DC</sub>	Output Duty Cycle	Measured at zero crossing point	48	–	52	%
T <sub>LOCK</sub>	Startup Time	Time for CLK to reach valid frequency measured from the time V <sub>DD</sub> = V <sub>DD(min.)</sub>	–	–	5	ms

**Recommended Crystal Specifications<sup>[4]</sup>**

Parameter	Description	Min	Max	Unit
Mode	Mode of Oscillation	Fundamental		
F	Frequency	22.4	28	MHz
ESR	Equivalent Series Resistance	–	50	Ω
C <sub>0</sub>	Shunt Capacitance	–	7	pF

**Parameter Measurements**

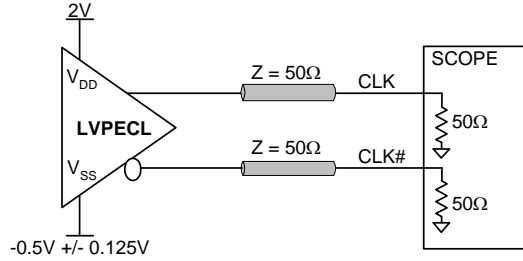
**Figure 2. 3.3V Output Load AC Test Circuit**



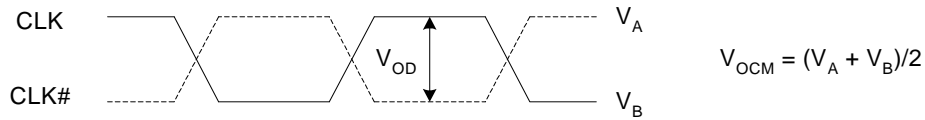
**Notes**

- 3. Not 100% tested, guaranteed by design and characterization.
- 4. Characterized using an 18 pF parallel resonant crystal.

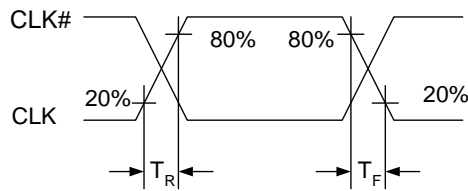
**Figure 3. 2.5V Output Load AC Test Circuit**



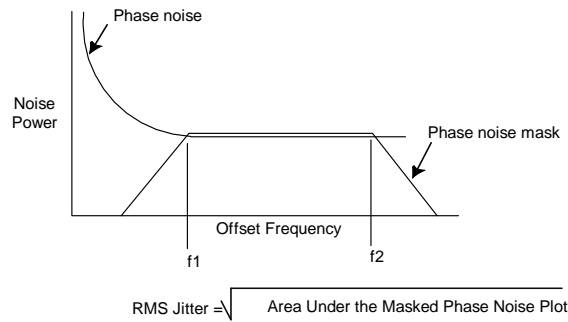
**Figure 4. Output DC Parameters**



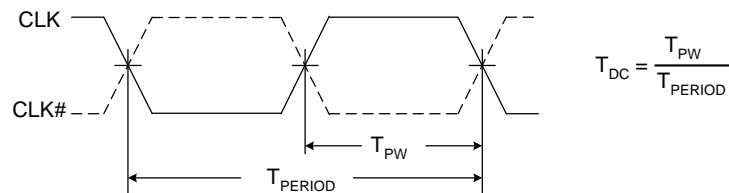
**Figure 5. Output Rise and Fall Time**



**Figure 6. RMS Phase Jitter**



**Figure 7. Output Duty Cycle**

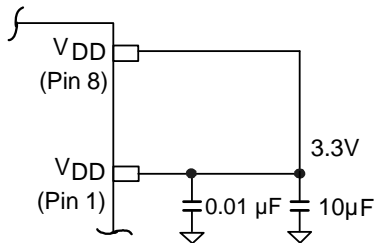


## Application Information

### Power Supply Filtering Techniques

As in any high speed analog circuitry, noise at the power supply pins can degrade performance. To achieve optimum jitter performance, use good power supply isolation practices. Figure 8 illustrates a typical filtering scheme. Since all the current flows through pin 1, the resistance and inductance between this pin and the supply is minimized. A 0.01 or 0.1  $\mu\text{F}$  ceramic chip capacitor is also located close to this pin to provide a short and low impedance AC path to ground. A 1 to 10  $\mu\text{F}$  ceramic or tantalum capacitor is located in the general vicinity of this device and may be shared with other devices.

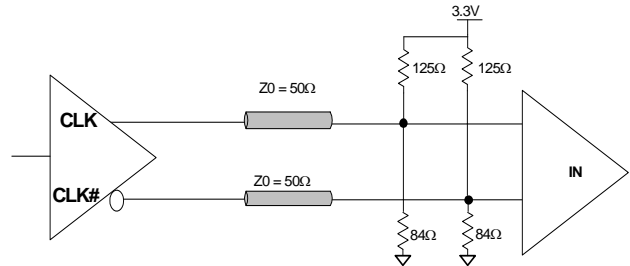
Figure 8. Power Supply Filtering



### Termination for LVPECL Output

The CY2XP21 implements its LVPECL driver with a current steering design. For proper operation, it requires a 50 ohm dc termination on each of the two output signals. For 3.3V operation, this data sheet specifies output levels for termination to  $V_{DD}-2.0\text{V}$ . This same termination voltage can also be used for  $V_{DD} = 2.5\text{V}$  operation, or it can be terminated to  $V_{DD}-1.5\text{V}$ . Note that it is also possible to terminate with 50 ohms to ground ( $V_{SS}$ ), but the high and low signal levels differ from the data sheet values. Termination resistors are best located close to the destination device. To avoid reflections, trace characteristic impedance ( $Z_0$ ) should match the termination impedance. Figure 9 shows a standard termination scheme.

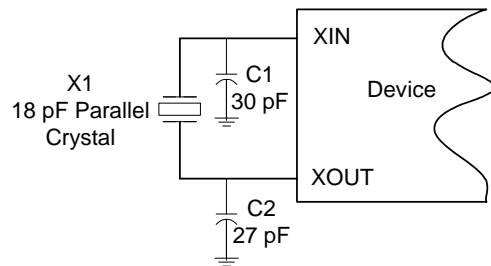
Figure 9. LVPECL Output Termination



### Crystal Interface

The CY2XP21 is characterized with 18 pF parallel resonant crystals. The capacitor values shown in Figure 10 are determined using a 25 MHz 18 pF parallel resonant crystal and are chosen to minimize the ppm error. Note that the optimal values for C1 and C2 depend on the parasitic trace capacitance and are thus layout dependent.

Figure 10. Crystal Input Interface



### Board Layout and NC Pin

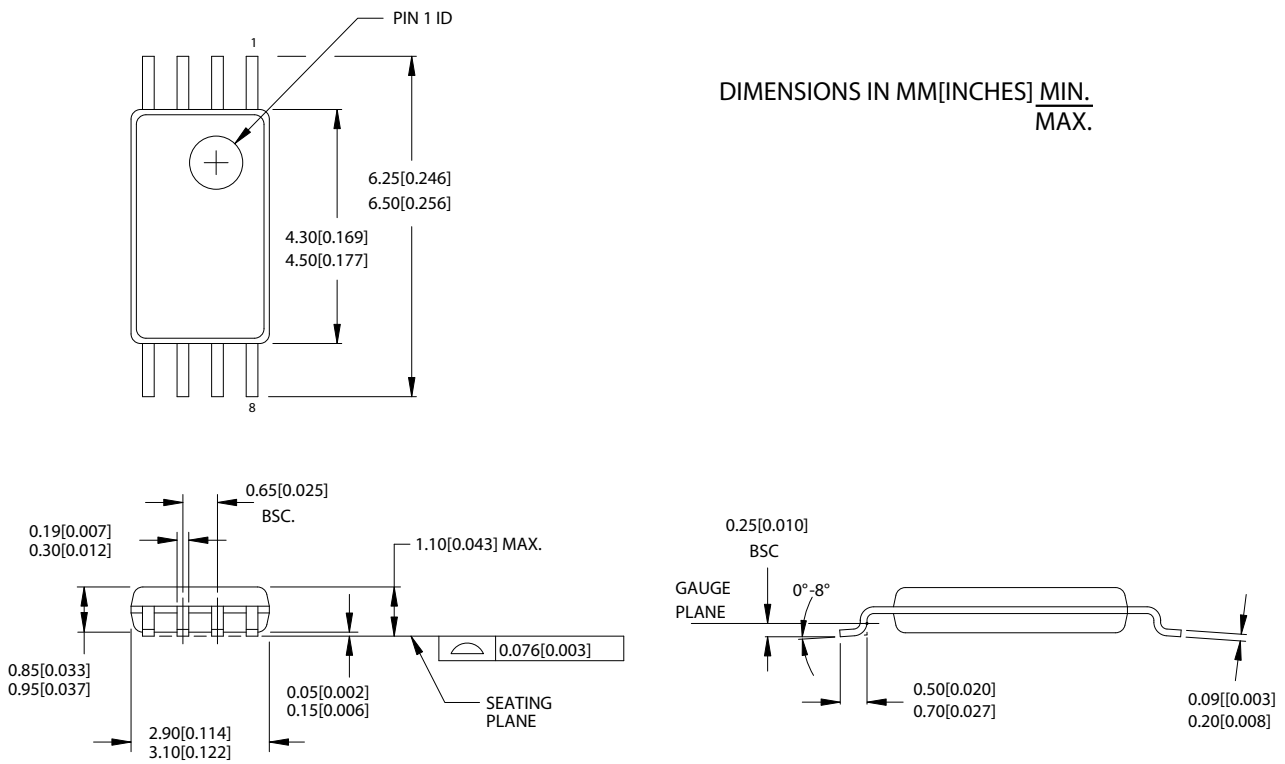
Pin 5 (NC) does not perform any function on the CY2XP21. Although not used electrically, it is very useful for heat dissipation. For this reason, users are advised to connect pin 5 to either a  $V_{DD}$  or  $V_{SS}$  plane. This helps to lower the thermal resistance of the board / package combination, thus reducing the die temperature.

**Ordering Information**

Part Number	Package Type	Product Flow
CY2XP21ZXC	8-pin TSSOP	Commercial, 0°C to 70°C
CY2XP21ZXCT	8-pin TSSOP - Tape and Reel	Commercial, 0°C to 70°C
CY2XP21ZXI	8-pin TSSOP	Industrial, -40°C to 85°C
CY2XP21ZXIT	8-pin TSSOP - Tape and Reel	Industrial, -40°C to 85°C

**Package Drawing and Dimensions**

**Figure 11. 8-Pin Thin Shrunken Small Outline Package (4.40 MM Body) Z8**



51-85093-\*A



**PRELIMINARY**

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## Document History Page

Document Title: CY2XP21 125 MHz LVPECL Clock Generator Document Number: 001-52849				
REV.	ECN NO.	Submission Date	Orig. of Change	Description of Change
**	2700242	04/30/09	KVM/PYRS	New data sheet
*A	2718898	06/15/09	WWZ	Minor ECN to post data sheet to external web
*B	2767298	09/22/09	KVM	Add I <sub>DD</sub> spec for unterminated outputs Change parameter name for I <sub>DD</sub> (terminated outputs) from I <sub>DD</sub> to I <sub>DDT</sub> Remove I <sub>DD</sub> footnote about externally dissipated current Add footnote reference to C <sub>INX</sub> :not 100% tested Add max limit for T <sub>R</sub> , T <sub>F</sub> : 1.0 ns Change T <sub>LOCK</sub> max from 10 ms to 5 ms

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